



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **10**

Number of Rows: **1**

Features

Product Type Features

PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Board-to-Board Configuration	Parallel
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	10
Number of Rows	1

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Mating Pin Diameter	.63 mm[.025 in]
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Mating Square Post Dimension	.64 mm[.025 in]



PCB Contact Termination Area Plating Material Thickness	2.5 µm
Contact Layout	Inline
Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Width	.7 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Method to PCB	Surface Mount

Mechanical Attachment

PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without

Housing Features

Mating Entry Location	Bottom & Top
Housing Material	LCP
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9 mm[.354 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]
Connector Height	6.2 mm[.244 in]

Usage Conditions

Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
-----------------------------	----------------------------

Operation/Application

Circuit Application	Signal
---------------------	--------

Industry Standards

UL Flammability Rating	UL 94V-0
------------------------	----------

Packaging Features



Packaging Quantity	700
Packaging Method	Reel

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

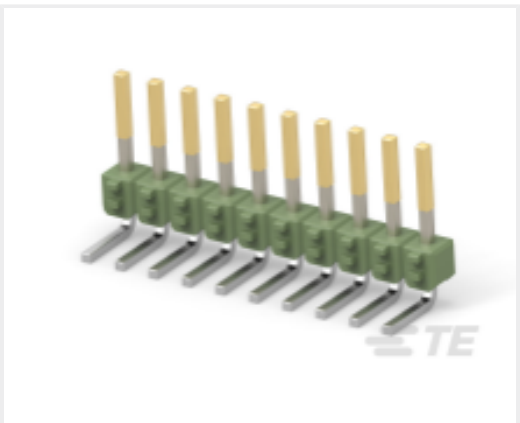
Compatible Parts



TE Part # 1-966710-0
MODU II PIN HEADER, SGL ROW,
SMD- 10 POS



TE Part # 1-826648-0
10P AMPMODU II STIFT LEI



TE Part # 1-826631-0
AMPMODU II R/A DR HEADER



TE Part # 1-966306-0
MOD2 ST-LEI SMD 10P



TE Part # 1-826630-0
10P AMPMODU II STIFT LEI

TE Part # 1-826647-0
10P AMPMODU II STIFT LEI

TE Part # 1-826646-0
10P AMPMODU II STIFT LEI

TE Part # 1-826629-0
10P AMPMODU II STIFT LEI

TE Part # 1-826652-0
10P AMPMODU II STIFT LEI

TE Part # 1-1241150-0
10P MOD II BREAK AWAY HDR,SMD, BLISTER

Also in the Series

AMPMODU HV-100/HV-190

Board-to-Board Headers & Receptacles(321)

PCB Headers & Receptacles(321)

Customers Also Bought

TE Part #8-1393238-3
RTD34005

TE Part #6116522-3
INV MJ,1X2,PNL GRD,SHLD

TE Part #1622872-1
CRG0603 1% 1K5

TE Part #1-282834-0
TERMI-BLOK PCB MOUNT, 90 10P.

TE Part #967116-1
MESSERLEISTE 18P

TE Part #1-338728-0
MICROM. MOB SMD CON

TE Part #1241152-6
6P HV100 REC. CON, SMD, GOLD, BLISTER

TE Part #8-338069-0
MICRO-MATCH SMD FTE



Documents

Product Drawings
[10P HV100 REC. CON, SMD, GOLD, BLISTER](#)
English

CAD Files
Customer View Model
[ENG_CVM_CVM_1-1241152-0_D.2d_dxf.zip](#)
English
[3D PDF](#)
3D
Customer View Model
[ENG_CVM_CVM_1-1241152-0_D.3d_igs.zip](#)
English
Customer View Model
[ENG_CVM_CVM_1-1241152-0_D.3d_stp.zip](#)
English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages
[1773393_ AMPMODU_EUROPEAN_STANDARD_PRODUCTS](#)
English